Transistor

Switching (45V, 6.0A) **SP8K24**

Features

1) Built-in G-S Protection Diode.

2) Small and Surface Mount Package (SOP8).

Applications

Power switching , DC / DC converter , Inverter

Structure

Silicon N-channel MOS FET

Packaging dimensions

Package	Taping		
Code	TB		
Basic ordering unit(pieces)	2500		

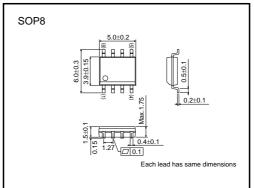
•Absolute maximum ratings (Ta=25°C)

It is the same ratings for the Tr. 1 and Tr. 2.

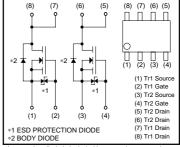
Parameter		Symbol	Limits	Unit	
Drain-source voltage		V _{DSS}	45	V	
Gate-source voltage		V _{GSS}	20	V	
Drain current	Continuous	I _D	±6.0	A	
Drain current	Pulsed	I _{DP}	±24	A *1	
Source current	Continuous	I _S	1	A	
(Body diode)	Pulsed	I _{SP}	24	A ^{*1}	
Total power dissipation		PD	2	W/TOTAL *2	
		١D	1.4	W/ELEMENT ^{*2}	
Chanel temperature		T_{ch}	150	°C	
Range of Storage temperature		T _{stg}	-55 to +150	°C	

*1 PW \leq 10 μ s, Duty cycle \leq 1%

•External dimensions (Unit : mm)



Equivalent circuit



A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

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•Electrical characteristics (Ta=25°C)

It is the same characteristics for the Tr. 1 and Tr. 2.

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Gate-source leakage	I _{GSS}	_	—	10	μΑ	V _{GS} =20V/V _{DS} =0V
Drain-source breakdown voltage	V _{(BR)DSS}	45	—	_	V	I _D =1mA/V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	_	—	1	μΑ	V _{DS} =45V/V _{GS} =0V
Gate threshold voltage	V _{GS(th)}	1.0	—	2.5	V	V _{DS} =10V/I _D =1mA
Static drain-source on-state resistance		_	18	25		I _D =6.0A/V _{GS} =10V
	R _{DS(on)} *	—	24	34	mΩ	I _D =6.0A/V _{GS} =4.5V
		_	26	37		I _D =6.0A/V _{GS} =4.0V
Forward transfer admittance	Y _{fs} *	6.0	_	_	S	V _{DS} =10V/I _D =6.0A
Input capacitance	C _{iss}	_	1400	_	pF	V _{DS} =10V
Output capacitance	C _{oss}	_	310	_		V _{GS} =0V
Reverce transfer capacitance	C _{rss}	_	175	_		f=1MHz
Turn-on delay time	t _{d(on)} *	—	19	_		V _{DD} =25V
Rise time	t _r *	_	30	_		I _D =3.0A
Turn-off delay time	t _{d(off)} *	—	72	—	ns	V _{GS} =10V
Fall time	t _f *	—	27	_		$R_L = 8\Omega/R_G = 10\Omega$
Total gate charge	Q _g *	—	15.4	21.6	nC	V _{DD} =25V/I _D =6.0A
Gate-source charge	Q _{gs} *	—	3.7	_		V _{GS} =5V
Gate-drain charge	Q _{gd} *	_	6.5	—		$R_L=4\Omega/R_G=10\Omega$

* pulsed

Body diode characteristics (Source-Drain)

It is the same characteristics for the Tr. 1 and Tr. 2.

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	V _{SD} *		-	1.2	V	I _S =6.0A/V _{GS} =0V
* 1 1						

* pulsed

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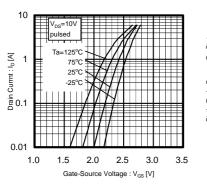


Fig.1 Typical Transfer Characteristics

Electrical characteristic curves

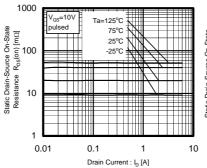


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current (1)

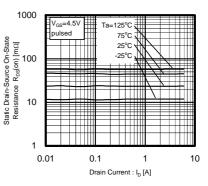


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (2)

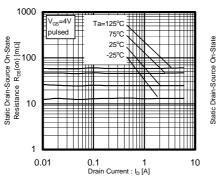


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (3)

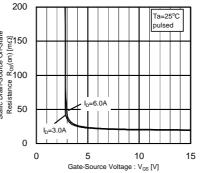
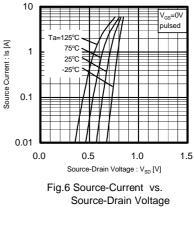


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage



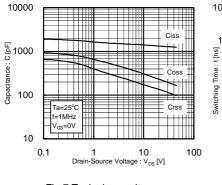


Fig.7 Typical capacitance vs. Source-Drain Voltage

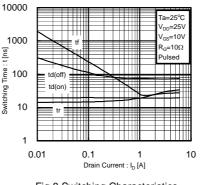
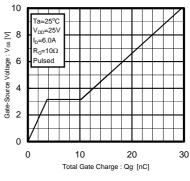
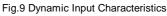


Fig.8 Switching Characteristics





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Measurement circuits

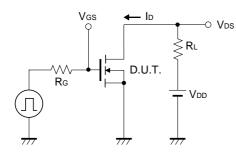


Fig.10 Switching Time Test Circuit

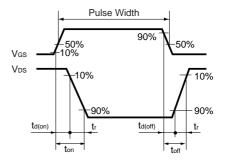


Fig.11 Switching Time Waveforms

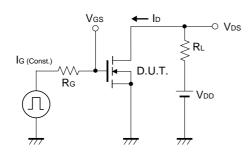
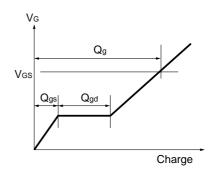


Fig.12 Gate Charge Test Circuit





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